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**PATENT** 

### THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): Tan et al.

Patent No.: 7,018,871 B2

Issued: March 28, 2006

For: SOLDER MASKS FOR USE ON CARRIER SUBSTRATES, CARRIER SUBSTRATES AND SEMICONDUCTOR DEVICE ASSEMBLIES INCLUDING SUCH SOLDER MASKS, AND METHODS

Attorney Docket No.: 2269-5163.1US

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

July 21, 2006 Date

Erika Gandre

Name (Type/Print)

# REQUEST FOR CERTIFICATE OF CORRECTION OF PATENT FOR APPLICANTS' MISTAKES (37 C.F.R. § 1.323) AND PATENT OFFICE MISTAKES (37 C.F.R./§612322)BESHAH1 00000016 7018871

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100.00 OP

Attn.: Certificate of Corrections Branch Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

It is noted that a combination of Applicant and Patent Office errors appear in this patent of a typographical nature or character and correction thereof does not involve such changes in the patent as would constitute new matter or would require reexamination. A certificate of correction in the form attached hereto is requested.

Certificate

JUL 2 7 2006

of Correction

Please send the Certificate to:

Name:

Brick G. Power

Address:

TraskBritt

P.O. Box 2550

Salt Lake City, Utah 84110

The fee of \$100.00 as required by 37 C.F.R. § 1.20(a) is enclosed.

Attached hereto in duplicate is Form PTO/SB/44 with at least one copy being suitable for printing.

Respectfully submitted,

Brick G. Power

Registration No. 38,581 Attorney for Applicant(s)

TRASKBRITT P.O. Box 2550

Salt Lake City, Utah 84110-2550

Telephone: 801-532-1922

Date: July 21, 2006

BGP/csw

Enclosures: PTO/SB/44 in duplicate

Check No. 22963 in the amount of \$100.00

Document in ProLaw

PATENT NO

7,018,871 B2

Page 1 of 4

DATED

March 28, 2006

INVENTOR(S):

Cher Khng Victor Tan; Choon Kaun Lee; Kian Chai Lee; Guek Har Lim; Wuu Yean Tay;

Teck Huat Poh; Cheng Poh Pour

It is certified that errors appear in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the title page:

In ITEM (75) "Inventors", 6th line,

change "Cheng Pour Poh," to -- Cheng Poh Pour, --

In ITEM (56) "References Cited, Other Publications", page 1, 1<sup>st</sup> entry, 2<sup>nd</sup> line,

change "Deviced" to --Devices--

In the drawings:

In FIG. 7,

move the dashed line square and associated reference numeral 23" and associated lead line to appear inside the solid line square labeled as 43" and change reference

numeral " 22" " to --20"--

In FIG. 10,

redirect the lead line associated with reference numeral 70 so that it rests at the top of the curve to indicate the conductive element and lengthen the lead line associated with reference numeral 60 so that it stops within the adhesive material appearing directly below device securing region 40"

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### In the specification:

COLUMN 6,	LINE 48,	change "to is" toto its
COLLBOIO	T TO TTO #0	1 // 1 /0.11

COLUMN 8, LINE 52, change "region 40." to --region 40".--

COLUMN 8, LINE 66, change "material." to --material, may be used to form

solder mask 30.--

COLUMN 10, LINE 29, after "encapsulant material 80" insert --(FIG. 8)--change "elements 70 (FIG. 8)." to --elements 70.--

#### In the claims:

CLAIM 9, COLUMN 11, LINE 30,

change "at least portion" to --at least a portion--

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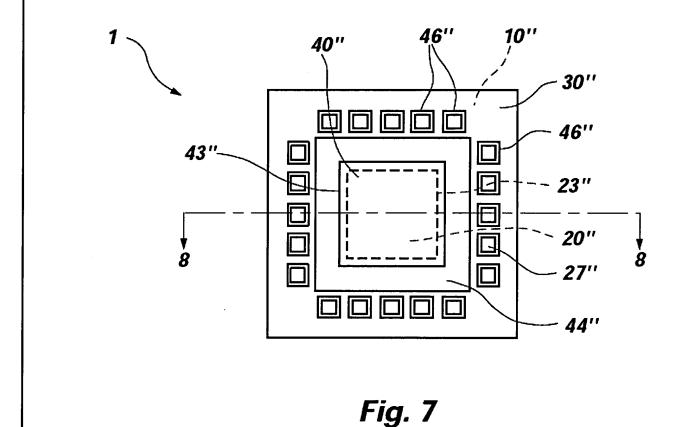
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### Replace FIG. 7 with the following:



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(Also Form PTO-1050)

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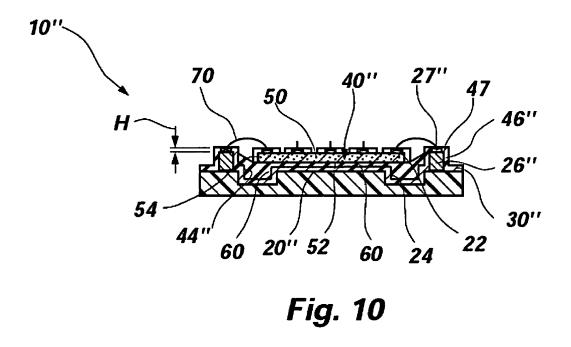
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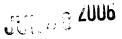


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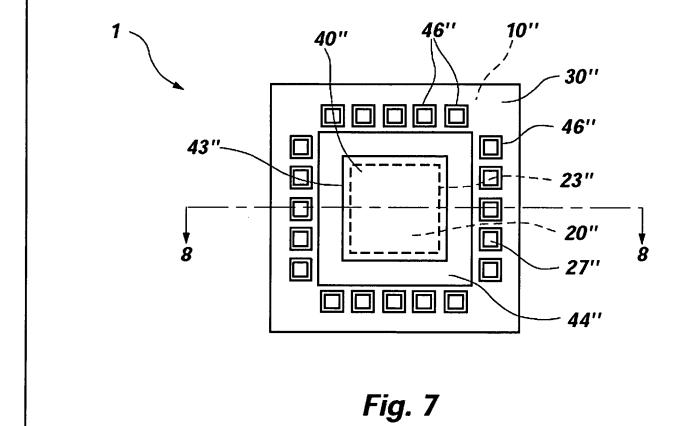
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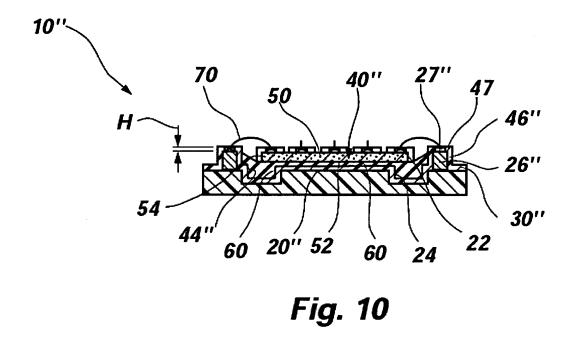
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